# GMAC97A6

## SENSITIVE GATE TRIACS SILICON BIDIRECTIONAL THYRISTORS 0.8A, 400V

#### Description

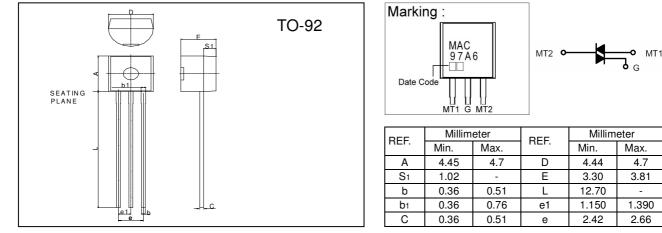
The GMAC97A6 device is designed for use in solid relays, MPU interface, TTL logic and any other light industrial or consumer application.

Supplied in an inexpensive TO-92 package which is readily adaptable for use in automatic insertion equipment.

#### Features

- Sensitive Gate Triggering in Four Trigger Modes (Quadrants) for all possible Combinations of Trigger Sources, and especially for Circuits that Source Gate Drives
- All Diffused and Glassivated Junction for Maximum Uniformity of parameters and Reliability

## **Package Dimensions**



#### Absolute Maximum Ratings (TJ=25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage(Note1) Sine Wave, 50 to 60Hz, Gate Open (TJ=-40 to 110 $^\circ$ C)	Vdrm Vrrm	400	V
On-state RMS Current, Full Cycle Sine Wave 50 to 60Hz (Tc=50 $^\circ$ C)	IT(RMS)	0.6	А
Peak Non-Repetitive Surge Current One Full Cycle, Sine Wave, 60Hz (Tc=110 $^\circ$ C)	Ітѕм	8	А
Circuit Fusing Consideration (t=8.3ms)	l <sup>2</sup> t	0.26	A <sup>2</sup> s
Peak Gate Power (t ≤ 2.0µs, Tc=80°C)	Рдм	5.0	W
Average Gate Power (t ≤ 8.3ms, Tc=80°C)	PG(AV)	0.1	W
Peak Gate Current (t ≤ 2.0µs, Tc=80°C)	Ідм	1.0	Α
Peak Gate Voltage (t ≤ 2.0µs, Tc=80°C)	Vgм	5.0	V
Operating Junction Temperature Rang	TJ	-40 ~ +110	°C
Storage Temperature Rage	Tstg	-40 ~ +150	°C

Note 1.VDRM and VRRM for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

### **Thermal Characteristics**

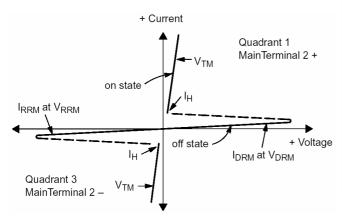
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-case	Rejc	75	°C/W
Thermal Resistance, Junction-to-Ambient	Reja	200	°C/W
Maximum Lead Temperature for soldering Purposes for 10 Seconds	ΤL	260	°C

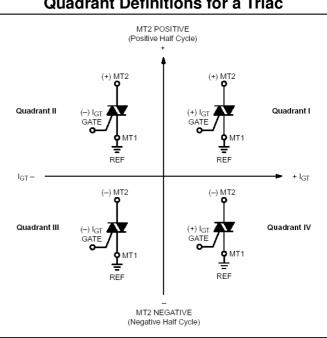
## **Electrical Characteristics** (Tc = $25^{\circ}$ C unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Тур	Max	Unit
Off Characteristics			•	•	•
Peak Repetitive Blocking Current (Note2) $T_J=25^{\circ}C$ (VDRM=400V and VRRM=400V; Gate Open) $T_J=110^{\circ}C$	Idrm,Irrm	-	-	10 100	μA
On Characteristics	I				
Peak On-State Voltage ≤ 2.0µs) (I⊤м=±0.85A Peak; Pulse Width ≤ 2.0ms, Duty Cycle ≤ 2.0%)	Vтм	-	-	1.9	V
Gate Trigger Current (Continuous dc) (VD=12.0 Vdc, RL=100Ω) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)	IGT	- - -		5.0 5.0 5.0 7.0	mA
Gate Trigger Voltage (Continuous dc) $(V_D=12.0 Vdc, R_L=100\Omega)$ MT2(+), G(+) All Types MT2(+), G(-) All Types MT2(-), G(-) All Types MT2(-), G(+) All Types	Vgt	- - - -	0.66 0.77 0.84 0.88	2.0 2.0 2.0 2.5	v
Gate Non-Trigger Voltage (VD=12.0 V, RL=100Ω TJ=110℃) All Four Quadrants	Vgd	0.1	-	-	V
Holding Current (VD=12.0 Vdc, Initiating Current=200mA, Gate Open)	Ін	-	1.5	10	mA
Turn-On Time (VD= VDRм=400V, Iтм=1.0A pk, Ig=25mA)	tgt	-	2.0	-	μs
Dynamic Characteristics					
Critical Rate of Rise of Commutation Voltage (VD=VDRM=400V, ITM=0.84A, Commutation di/dt=0.3A/ms, Gate Unenergized, Tc=50℃)	dV/dt (c)	-	5.0	-	V/µs
Critical Rate of Rise of Off-State Voltage (VD=VDRM=400V, Tc=110℃, Gate Open, Exponential Waveform)	dv/dt	-	25	-	V/µs

## Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter	
Vdrm	Peak Repetitive Forward Off State Voltage	
Idrm	Peak Forward Blocking Current	
VRRM	Peak Repetitive Reverse Off State Voltage	
IRRM	Peak Reverse Blocking Current	
Vтм	Maximum On State Voltage	
Ін	Holding Current	



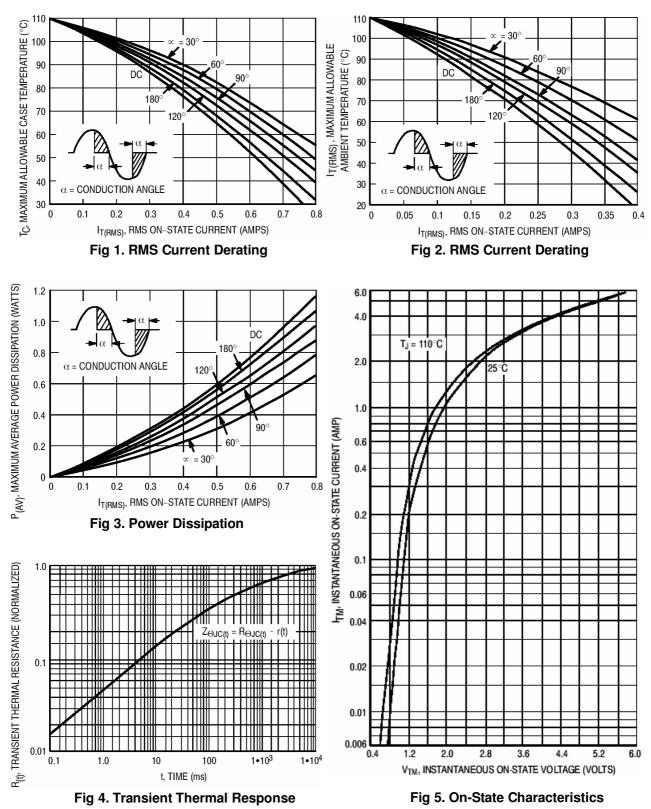


All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants  $\ {\rm I}$  and  ${\rm I\hspace{-.1em}I}$  are used

# Quadrant Definitions for a Triac

# Characteristics Curve



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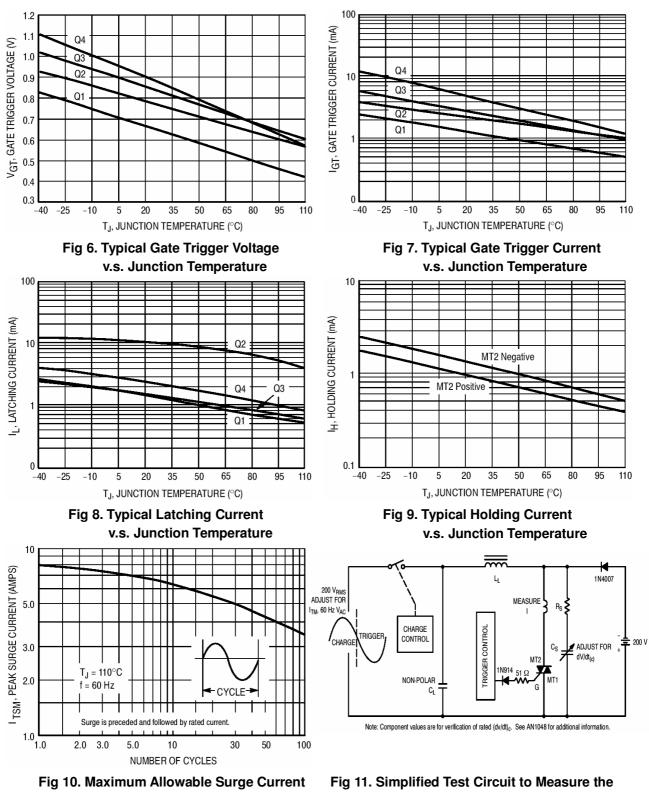


Fig 11. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Voltage (dV/dt)c

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